

Qualified Levels: RoHS JAN, JANTX, JANTXV **PNP Silicon Low-Power Transistor** Compliant and JANS commercial Qualified per MIL-PRF-19500/485 version DESCRIPTION This family of 2N5415S and 2N5416S epitaxial planar transistors are military qualified up to a JANS level for high-reliability applications. These devices are also available in the longer leaded TO-5 and low profile U4 and UA packaging. Important: For the latest information, visit our website http://www.microsemi.com. **FEATURES TO-205AD** JEDEC registered 2N5415 through 2N5416 series . (TO-39) Package JAN, JANTX, JANTXV, and JANS qualifications are available per MIL-PRF-19500/485. (See part nomenclature for all available options.) RoHS compliant commercial version Also available in: TO-5 package (long-leaded) 2N5415 - 2N5416 **APPLICATIONS / BENEFITS** U4 package General purpose transistors for low power applications requiring high frequency switching. (surface mount) 🔁 <u>2N5415U4 –</u> 2N5416U4 Low package profile. Military and other high-reliability applications. **UA** package (surface mount) 🚹 <u>2N5415UA – 2N5416UA</u> MAXIMUM RATINGS @ T_A = +25 °C unless otherwise noted Parameters / Test Conditions Symbol 2N5415S 2N5416S Unit V Collector-Emitter Voltage VCEO 200 300 V_{CBO} V Collector-Base Voltage 200 350 V Emitter-Base Voltage VEBO 6.0 6.0 MSC – Lawrence 1.0 1.0 A **Collector Current** Ic 6 Lake Street. T_J, T_{stg} °C Lawrence, MA 01841 **Operating & Storage Junction Temperature Range** -65 to +200 Tel: 1-800-446-1158 or Thermal Resistance Junction-to-Ambient 234 °C/W R_{ØJA} (978) 620-2600 Thermal Resistance Junction-to-Case R_{eJC} 17.5 °C/W Fax: (978) 689-0803 @ $T_A = +25 \ ^{\circ}C^{(1)}$ **Total Power Dissipation** 0.75 Pτ W MSC – Ireland @ $T_c = +25 °C^{(2)}$ 10 Gort Road Business Park, Ennis, Co. Clare, Ireland Tel: +353 (0) 65 6840044

Notes: 1. Derate linearly 4.29 mW/°C for TA > +25 °C.

2. Derate linearly 57.2 mW/°C for $T_C > +25$ °C.

Fax: +353 (0) 65 6822298

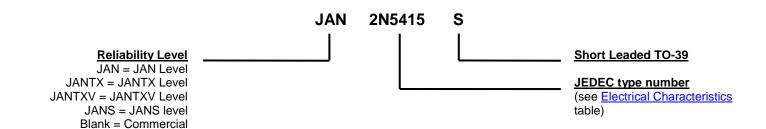
T4-LDS-0305-1, Rev. 1 (7/30/13)



MECHANICAL and PACKAGING

- CASE: Hermetically sealed, kovar base, nickel cap
- TERMINALS: Gold plated kovar and solder dip (Sn63/Pb37) on JAN, JANTX, and JANTXV versions. NOTE: Solder dipped versions are not RoHS compliant.
- MARKING: Part number, date code, manufacturer's ID and serial number
- POLARITY: PNP
- WEIGHT: Approximately 1.064 grams
- See <u>Package Dimensions</u> on last page.

PART NOMENCLATURE



SYMBOLS & DEFINITIONS					
Symbol	Definition				
C _{obo}	Common-base open-circuit output capacitance				
I _{CEO}	Collector cutoff current, base open				
I _{CEX}	Collector cutoff current, circuit between base and emitter				
I _{EBO}	Emitter cutoff current, collector open				
h _{FE}	Common-emitter static forward current transfer ratio				
V _{CEO}	Collector-emitter voltage, base open				
V _{CBO}	Collector-emitter voltage, emitter open				
V _{EBO}	Emitter-base voltage, collector open				



ELECTRICAL CHARACTERISTICS @ T_A = +25 °C, unless otherwise noted

OFF CHARACTERISTICS

Parameters / Test Conditions		Symbol	Min.	Max.	Unit
Collector-Emitter Breakdown Voltage $I_{C} = 50 \text{ mA}, I_{B} = 5 \text{ mA}, L = 25 \text{ mH}; f = 30 - 60 \text{ Hz}$	2N5415S 2N5416S	V _{(BR)CEO}	200 300		V
Emitter-Base Cutoff Current $V_{EB} = 6.0 V$		I _{EBO}		20	μA
Collector-Emitter Cutoff Current $V_{CE} = 200 \text{ V}, V_{BE} = 1.5 \text{ V}$ $V_{CE} = 300 \text{ V}, V_{BE} = 1.5 \text{ V}$	2N5415S 2N5416S	I _{CEX}		50	μA
Collector-Emitter Cutoff Current $V_{CE} = 150 V$ $V_{CE} = 250 V$	2N5415S 2N5416S	I _{CEO1}		50	μA
Collector-Emitter Cutoff Current $V_{CE} = 200 V$ $V_{CE} = 300 V$	2N5415S 2N5416S	I _{CEO2}		1	mA
Collector-Base Cutoff Current $V_{CB} = 175 V$ $V_{CB} = 280 V$	2N5415S 2N5416S	I _{CBO1}		50	μΑ
V _{CB} = 200 V V _{CB} = 350 V	2N5415S 2N5416S	I _{CBO2}		500	μA
V _{CB} = 175 V, T _A = +150 °C V _{CB} = 280 V, T _A = +150 °C	2N5415S 2N5416S	I _{CBO3}		1	mA

ON CHARACTERISTICS

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Forward-Current Transfer Ratio $I_C = 50 \text{ mA}, V_{CE} = 10 \text{ V}$ $I_C = 1 \text{ mA}, V_{CE} = 10 \text{ V}$ $I_C = 50 \text{ mA}, V_{CE} = 10 \text{ V}, T_A = +150 \text{ °C}$	h _{FE}	30 15 15	120	
Collector-Emitter Saturation Voltage $I_{C} = 50 \text{ mA}, I_{B} = 5 \text{ mA}$	V _{CE(sat)}		2.0	V
Base-Emitter Voltage Non-Saturation $I_{C} = 50 \text{ mA}, V_{CE} = 10 \text{ V}$	V_{BE}		1.5	V

DYNAMIC CHARACTERISTICS

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Magnitude of Common Emitter Small-Signal Short- Circuit Forward Current Transfer Ratio $I_{C} = 10 \text{ mA}, V_{CE} = 10 \text{ V}, f = 5 \text{ MHz}$	h _{fe}	3	15	
Small-signal short Circuit Forward-Current Transfer Ratio $I_{C} = 5 \text{ mA}, V_{CE} = 10 \text{ V}, f \le 1 \text{ kHz}$	h _{fe}	25		
Output Capacitance $V_{CB} = 10 \text{ V}, I_E = 0, 100 \text{ kHz} \le f \le 1 \text{ MHz}$	C _{obo}		15	pF



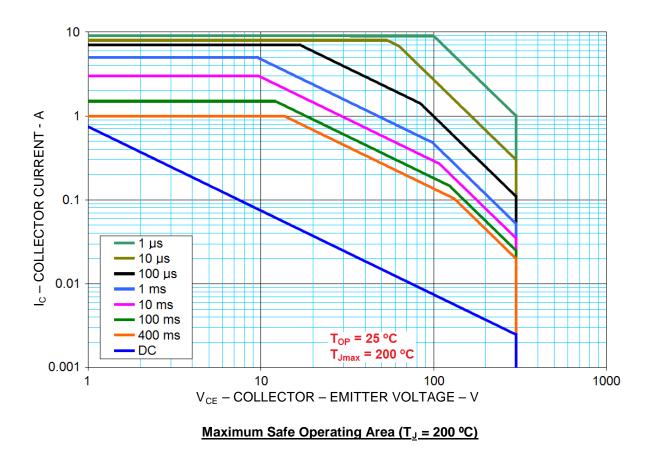
ELECTRICAL CHARACTERISTICS @ $T_A = +25$ °C unless otherwise noted. (continued)

SWITCHING CHARACTERISTICS

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Turn-On Time $V_{CC} = 200 \text{ V}, I_C = 50 \text{ mA}, I_{B1} = 5 \text{ mA}$	t _{on}		1	μs
Turn-Off Time $V_{CC} = 200 \text{ V}, I_C = 50 \text{ mA}, I_{B1} = I_{B2} = 5 \text{ mA}$	t _{off}		10	μs

SAFE OPERATING AREA (See SOA graph below and <u>MIL-STD-750, method 3053</u>)

 $\begin{array}{l} \textbf{DC Tests} \\ T_{C} = +25 \ ^{\circ}\text{C}, \ t_{P} = 0.4 \ \text{s}, \ 1 \ \text{Cycle} \\ \hline \textbf{Test 1} \\ V_{CE} = 10 \ \text{V}, \ I_{C} = 1 \ \text{A} \\ \hline \textbf{Test 2} \\ V_{CE} = 100 \ \text{V}, \ I_{C} = 100 \ \text{mA} \\ \hline \textbf{Test 3} \\ V_{CE} = 200 \ \text{V}, \ I_{C} = 24 \ \text{mA} \ (2\text{N5415S only}) \\ \hline \textbf{Test 4} \\ V_{CE} = 300 \ \text{V}, \ I_{C} = 10 \ \text{mA} \ (2\text{N5416S only}) \end{array}$





GRAPHS

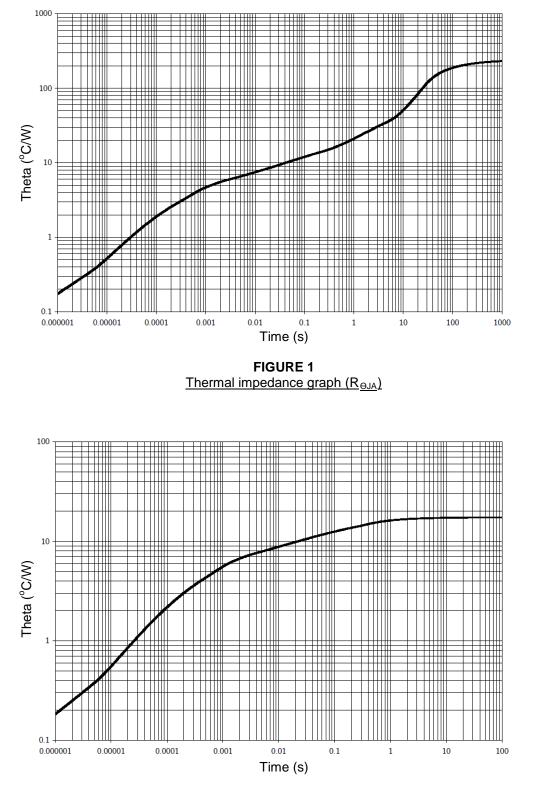
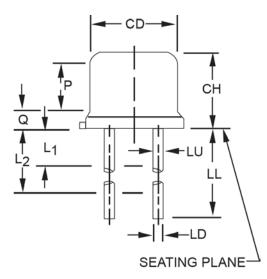


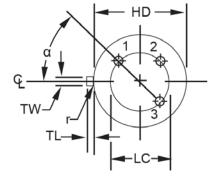
FIGURE 2 Thermal impedance graph (R_{OJA})

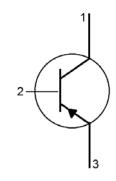


PACKAGE DIMENSIONS



	Dimensions				
Symbol	Inch		Millim	Notes	
	Min	Max	Min	Max	
CD	0.305	0.335	7.75	8.51	
СН	0.240	0.260	6.10	6.60	
HD	0.335	0.370	8.51	9.40	
LC	0.200 TP		5.08	3 TP	6
LD	0.016	0.021	0.41	0.53	7, 8
LL	0.500	0.750	12.70	19.05	7, 8
LU	0.016	0.019	0.41	0.48	7, 8
L ₁	-	0.050	-	1.27	7, 8
L ₂	0.250	-	6.35	-	7, 8
Q	-	0.050	-	1.27	5
TL	0.029	0.045	0.74	1.14	4
TW	0.028	0.034	0.71	0.86	3
r	-	0.010	-	0.25	10
α	45° TP		45° TP		6
Р	0.100	-	2.54	-	





NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for information only.
- 3. Beyond r (radius) maximum, TW shall be held for a minimum length of 0.011 (0.28 mm).
- 4. Dimension TL measured from maximum HD.
- 5. Body contour optional within zone defined by HD, CD, and Q.
- Leads at gauge plane 0.054 +0.001 -0.000 inch (1.37 +0.03 -0.00 mm) below seating plane shall be within 0.007 inch (0.18 mm) radius of true position (TP) at maximum material condition (MMC) relative to tab at MMC. This device may be measured by direct methods.
- Dimension LU applies between L1 and L2. Dimension LD applies between L2 and minimum. Diameter is uncontrolled in L1 and beyond LL minimum.
- 8. All three leads.
- 9. The collector shall be internally connected to the case.
- 10. Dimension r (radius) applies to both inside corners of tab.
- 11. In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.
- 12. Lead 1 =emitter, lead 2 =base, lead 3 =collector.

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Microchip: Jantx2N5416S